Abstract

The production of superconducting coatings for radio frequency cavities is a rapidly developing field that should ultimately lead to acceleration gradients greater than those obtained by bulk Nb RF cavities. The use of thin films made from superconductors with thermodynamic critical field, $H_c > H_{c}^{Nb}$, allows the possibility of multilayer superconductor – insulator – superconductor (SIS) films and also accelerators that could operate at temperatures above the 2 K typically used. SIS films theoretically allow increased acceleration gradient due to magnetic shielding of underlying superconducting layers [1] and higher operating temperature can reduce cost [2]. High impulse magnetron sputtering (HiPIMS) and pulsed DC magnetron sputtering processes were used to deposit NbN and NbTiN thin films onto Si(100) substrate. The films were characterised using scanning electron microscopy (SEM), x-ray diffraction (XRD), Rutherford back-scattering spectroscopy (RBS) and a four point probe.

INTRODUCTION

Superconducting radio frequency (SRF) cavity technology in particle accelerators is now reaching the limit of performance achievable with bulk Nb cavities [3]. Since superconducting properties for SRF are confined to a penetration depth of less than one micron [4] then superconducting thin-films offer an alternative to bulk Nb with the advantage of Cu substrates which have a factor of three higher thermal conductivity than Nb [5]. Multilayer SIS films have been suggested as a way to increase accelerating voltages further by utilising an increased first critical field ($B_{c1}$) for superconducting layers with $H_c > H_c^{Nb}$ and thickness ($d$) less than $\lambda$, to shield an underlying Nb layer (Fig. 1). Equation 1 shows that as film thickness and coherence length, $\xi$, get smaller then $B_{c1}$ increases in the overlying superconducting layers [1]:

$$B_{c1} = \frac{2 \Phi_0}{\pi a^2} \ln \frac{d}{1.07 \xi}, \quad d < \lambda .$$ (1)

Another use of superconducting materials other than Nb is to reduce the surface resistance ($R_s$) of SRF cavities which allows for higher Q factors. Superconductors with $T_C > T_c^{Nb}$ have been shown to have a lower $R_s$ than Nb at 4.2 K due to the fact that $R_s \propto e^{-T_c/T}$ [6]. It is also possible to reduce $R_s$ further by combining higher $T_C$ with as small a normal state low temperature resistivity as possible [7]. Operation at 4.2 K can provide reduced operational costs.

Figure 1: A schematic representation of an SIS multilayer film deposited on to Cu substrate.

The purpose of the present study is to deposit and then characterise a selection of NbN and NbTiN thin films that would be suitable for use in both SIS multilayer coatings or for operation in accelerators at 4.2 K. NbN was chosen for to its $H_c$ of 0.23 T which is higher than the 0.2 T of Nb. NbN also has a high $T_C$ of 17.3 K, small $\xi$ of 2.9 nm and $\lambda$ of 375 nm [6]. One drawback of NbN is its high normal state resistivity. NbTiN was therefore considered due to its smaller resistivity than NbN [2], higher $T_C$ of 18 K, $\xi$ of 3.8 nm [8] and $\lambda$ of 150 nm. Films were deposited by reactive sputtering in a mixture of Kr and N$_2$ gas using three inch planar magnetrons utilising either an Ionautics.
HiPSTER 1000 high impulse magnetron sputtering (HiPIMS) power supply or an Advanced Energy Pinnacle + pulsed DC power supply. The HiPIMS power supply creates a characteristic peak current which is up to two orders of magnitude higher than that of the pulsed DC. High current densities at the target allow for dense plasma with the possibility that sputtered atoms will become ionised [9]. Variable parameters during the experiment included the temperature of the substrate, N2 partial pressure and the current supplied by the pulsed DC supply.

EXPERIMENTAL

Thin film samples were deposited onto Si (100) substrates in a mixture of both Kr and N2 sputter gasses. The base pressure of the deposition chamber was ~10^{-8} mbar and the pressure was maintained at 7×10^{-3} mbar during deposition. Each substrate was first prepared by cleaning in ultrasonic baths of acetone then IPA and finally rinsed in deionised water. All sample substrates were set to continuously rotate at 4 rpm during deposition at either room temperature or 385°C. NbN films were deposited for 3 hours by HiPIMS with an average current of 670 mA, peak current of 28 A, 1000 Hz repetition rate and 50 μs pulse length. N2 partial pressure was then varied for each deposition so that the fraction of N2 from the total gas pressure ranged 10 to 22%.

NbTiN films were deposited by dual magnetron sputtering. One magnetron fitted with a Nb target was powered by the HiPIMS power supply whilst another used a Ti target and the pulsed DC supply. NbTi films were first deposited to evaluate the correct settings of the pulsed DC supply. The HiPIMS supply maintained constant settings of 590 mA average current, 20 A peak current, 1000 Hz repetition rate and 50 μs pulse length. The pulsed DC supply was set to pulse at 350 kHz with a 50% duty cycle and an average current which varied from 0.4 to 1.2 A. It was found that 0.96 A provided by the pulsed DC supply produced NbTi with 34 atomic % Ti. 0.96 A was therefore considered the optimum current setting for the pulsed DC supply as the highest $T_c$ in the literature occurs for films with fraction Nb_{1-x}Ti_xN where $x = 0.34$ [8]. The optimum power settings were then maintained whilst N2 partial pressure was varied as described for NbN.

Morphological characterisation of each film was performed by SEM, XRD and RBS. The SEM was used to measure the thickness of films and determine the film structure. XRD was used to determine the phase, preferred growth orientation and average grain size of films. RBS was used to quantify the elemental stoichiometry.

A four point probe was used to determine the superconducting transition temperature ($T_c$) followed by a calculation of the normal state DC resistivity.

$T_c$ was measured for all samples deposited. NbN samples ranged in $T_c$ from 7 to 16.1 K (Fig. 2). NbN samples deposited with a substrate temperature of 385°C showed no superconductivity for samples deposited in Kr and N2 atmosphere containing 10% partial pressure of N2 or below. Samples became superconducting at 11% N2 with the lowest $T_c$ of 7 K. $T_c$ of the NbN samples then increased with nitrogen partial pressure up to a maximum 16.1 K at 22% N2. It has previously been reported in the literature that increasing the temperature of the substrate during deposition will increase the $T_c$ for NbN films [10]. Only two samples were deposited at room temperature and had reduced $T_c$ of 10.7 and 10.3 K at partial pressures of 18 and 22% N2, respectively.

Figure 2: Transition temperatures for NbN thin films for varying nitrogen partial pressure. Substrate was maintained at 385°C.

A selection of NbN samples were measured by SEM, XRD and RBS. Figure 3 was typical of the films deposited. NbN films were made up of columnar grains with voids. Voids were of a comparable size to the columnar structure. It has been previously reported that the high resistivity of NbN is due to the presence of metallic and gaseous voids [11]. The thicknesses of only two NbN films were measured by SEM. Both samples were deposited with a 22% N2 partial pressure however one with a substrate heated to 385°C and the other...
deposited at room temperature. The measurement of the thickness of the samples allowed the normal state DC resistivity at just above $T_c$ to be calculated and resulted in $835\pm260 \, \mu\Omega\text{cm}$ for the high temperature deposition and $2094\pm650 \, \mu\Omega\text{cm}$ for the room temperature deposition. This result shows improved electrical performance for the substrate heated to 385°C when compared to a similar room temperature deposition.

All NbN samples which were measured by XRD showed the fcc phase with preferred growth orientation (111) (Fig. 4). The grain sizes of NbN films deposited at 385°C ranged from 43 to 51 nm with the largest grains of 51 and 48 nm occurring at N$_2$ partial pressures of 20 and 22% respectively. The grain size was measured for only one film deposited at room temperature. The film was deposited with 22% N$_2$ partial pressure and produced reduced grain size of 38 nm when compared to the same deposition conditions at 385°C.

**Figure 4**: NbN thin film with $T_c = 16.1$ K. Sample was deposited with 22% N$_2$ partial pressure. XRD shows the fcc phase with preferred orientation (111).

All NbTiN samples were deposited at a substrate temperature of 385°C. Samples showed no superconductivity when deposited with an N$_2$ partial pressure of 11% or below. Samples were superconducting at a partial pressure of 14% N$_2$ upwards to 21% and the maximum $T_c$ of 17.8 K occurring at 20% (Fig. 6).

**Figure 6**: Transition temperatures of NbTiN thin films for varying nitrogen partial pressure. Substrate was maintained at 385°C.

RBS analysis of NbN samples show the presence of O contamination within the films (Fig. 5). The sample with the highest $T_c$ of 16.1 K contained atomic percentages of 47.5% Nb, 42.6% N and 9.9% O. A possible source of O contamination could be outgassing from the unbaked vacuum system. Another possible source of O contamination is ex-situ post-deposition oxidation. SEM images showed a very rough surface with columnar grains that provide a large surface area for possible surface oxidation. There was no leak in the vacuum system. Further XPS measurements are planned to elucidate the origin of the O contamination.

**Figure 5**: RBS data showing the ratio of N and Nb in the NbN film with highest $T_c = 16.1$ K. Measurement also shows the presence of O contamination. Measurement was performed using a hydrogen beam with 10° angle of incidence, 165° scattering angle and 25° exit angle.

**Figure 7**: RBS data showing the elemental ratio of Nb, Ti and N in an NbTiN thin film. Measurement was performed using a hydrogen beam with 10° angle of incidence, 165° scattering angle and 25° exit angle.

RBS analysis showed no oxygen contamination in the two NbTiN films which were measured (Fig. 7). The correct stoichiometry for the highest $T_c$ in the literature would correspond to 33% Nb, 17% Ti and 50% N. Our
films came closest to these values for the film deposited in a 20% partial pressure of N\textsubscript{2} and resulted in the highest $T\text{\textsubscript{C}}$ of 17.8 K (Table 1). It has been assumed that by altering the deposition conditions for future depositions then films can be produced with the desired ratios i.e. altering the current supplied to the Nb and Ti targets and the N\textsubscript{2} pressure accordingly to change the elemental percentages as required.

Table 1: Table showing the elemental composition of two NbTiN films deposited in N\textsubscript{2} partial pressures (N\textsubscript{2} P\textsubscript{\%}) of 38 and 18%.

<table>
<thead>
<tr>
<th>N\textsubscript{2} P\textsubscript{%}</th>
<th>$T\text{\textsubscript{C}}$ (K)</th>
<th>Nb (at.%)</th>
<th>Ti (at.%)</th>
<th>N (at.%)</th>
<th>O (at.%)</th>
</tr>
</thead>
<tbody>
<tr>
<td>20</td>
<td>17.8</td>
<td>37.7</td>
<td>16.2</td>
<td>46.1</td>
<td>0</td>
</tr>
<tr>
<td>18</td>
<td>16.7</td>
<td>41.7</td>
<td>16.2</td>
<td>42.4</td>
<td>0</td>
</tr>
</tbody>
</table>

The normal state DC resistivity was calculated for the only NbTiN sample with a measured thickness. This sample showed the highest $T\text{\textsubscript{C}}$ of 17.8 K and the corresponding resistivity was $45\pm7 \ \mu\text{\Omega}\text{\textsubscript{cm}}$. The measured NbTiN resistivity was an order of magnitude improvement over the resistivity measured for the highest $T\text{\textsubscript{C}}$ NbN sample.

**CONCLUSIONS**

The study set out to use HiPIMS to produce NbN and NbTiN thin films with comparable or higher $T\text{\textsubscript{C}}$ to those presented in the literature to date. NbN films were produced first and showed a maximum $T\text{\textsubscript{C}}$ of 16.1 K and a normal state DC resistivity of $835\pm260 \ \mu\text{\Omega}\text{\textsubscript{cm}}$. RBS measurements of these films showed the films to be non-stoichiometric and contained some contamination by O. Possible origins of the contamination are outgassing from the unbaked vacuum system or ex-situ post deposition surface oxidation.

NbTiN films were produced in order to test their increased $T\text{\textsubscript{C}}$ and superior electrical properties when compared to NbN. Our results showed a highest $T\text{\textsubscript{C}}$ of 17.8 K and a normal state DC resistivity of $45\pm7 \ \mu\text{\Omega}\text{\textsubscript{cm}}$. The NbTiN film had an order of magnitude lower resistivity than that of the best NbN sample. This sample was close to stoichiometric ratios reported previously in the literature to achieve the highest $T\text{\textsubscript{C}}$.

**REFERENCES**